WHAT IS CLAIMED IS:

1. A substrate construction for immobilizing a physiological material comprising:

a substrate;

an organic polymer linker material layer formed on the substrate; and

a gold thin layer formed on the organic polymer linker material layer, wherein the organic polymer linker material layer has a thickness ranging from 30 to 200nm and shows peaks of 111 and 200 planes using X-ray diffractometry when the X-rays radiate at an incident angle of 1.5.

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2. The substrate construction according to claim 1, wherein the substrate is selected from the group consisting of glass, polycarbonate, polyester, polyethylene, polypropylene, and wafer.

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3. The substrate construction according to claim 1, wherein one terminal end of the organic polymer linker material has a functional group that is capable of reacting with a functional group of the substrate and another terminal end has a functional group with a positive charge that is capable of undergoing ionic interaction with a negative charge of a gold colloid surface.

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4. The substrate construction according to claim 1, wherein the organic polymer linker material is represented by the formula:

 $X-R_1-Si(R_2)_3$

where X is a functional group having a positive charge that is capable of undergoing ionic interaction with a negative charge of a gold colloid surface, R_1 is a spacer of $(CH_2)_n$ or $(CH_2)_n$ having one or more carboxyl or imino groups replacing one or more of the ethylene monomers, where n is an integer from 1 to 8, and $Si(R_2)_3$ is a functional group that is capable of reacting with functional groups on the substrate surface where each R_2 is independently selected from the group consisting of alkoxy groups, halides, and aldehyde groups.

5. The substrate construction according to claim 1, wherein the functional group with a positive charge is an imine group.

- The substrate construction according to claim 5, wherein the functional 6. group with a positive charge is a functional group having at least two imine groups.
- 7. The substrate construction according to claim 3, wherein the organic polymer linker material is selected from the group consisting of a viologen-based compound having a formula selected from (2a), (2b) and (2c), a polymer having an imine group-containing polyethylene backbone having formula (3), a compound having formula (4) and a compound having formula (5):

$$\begin{array}{c} O \\ II \\ O \end{array} \begin{array}{c} (CH_2)_h \\ Si(R_2)_3 \end{array}$$

$$+ N \\ + N \\ O \\ (CH_2)_h \end{array} \begin{array}{c} Si(R_2)_3 \\ O \\ (CH_2)_h \end{array} \tag{2a}$$

$$+N$$
 $+N$
 $(CH_2)_j$
 $Si(R_2)_3$
(2c)

$$\begin{bmatrix}
H & H & H \\
N & (CH_2)_k & N
\end{bmatrix}$$

$$Si(R_2)_3$$
(3)

$$R_{3}N \xrightarrow{N} S^{-1} Si(R_{2})_{2}$$

$$NR_{4}$$

$$(4)$$

$$R_5$$

$$N$$

$$(CH_2)_{\infty} - Si(R_2)_3$$
(5)

where each R_2 is independently selected from the group consisting of alkoxy groups, halides, and aldehyde groups; h, h', I and m are integers from 1 to 8; R_3 and R_4 are independently (R_6)₂ where R_6 is a halogen or a C_1 to C_6 alkyl; and R_5 is a halogen or a C_4 to C_6 alkyl.

8. The substrate construction according to claim 7, wherein the organic polymer linker material is selected from the group consisting of a compound having a formula selected from (2a'), (2b') or (2c'), a polymer having formula (3'), a methylene bule compound having formula (4') and a phenazine methosulphate compound having formula (5'):

$$+N \longrightarrow 0 \longrightarrow Si(R_2)_3$$

$$+N \longrightarrow 0 \longrightarrow Si(R_2)_3$$

$$= 0 \longrightarrow Si(R_2)_3$$

 $\begin{bmatrix}
H & CI^{-} & H \\
N & N^{\dagger} & N^{\dagger}
\end{bmatrix}$ Si(R₂)₃
(3')

$$(CH_3)_2 N$$
 $Si(R_2)_3$
 $N(CH_3)_2$
 $(4')$

where each $\,\,$ R $_{2}$ is independently selected from the group consisting of alkoxy

groups, halides and aldehyde groups.

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- 9. The substrate construction according to claim 6, wherein the organic polymer linker material comprises trimethoxysilylpropyl polyethyleneimine.
- 10. A biochip comprising a physiological material immobilized on a surface of the substrate according to claim 1.
- 11. A biochip according to claim 10, wherein the physiological material is selected from the group consisting of enzymes, proteins, DNA, RNA, microbes, microorganisms, animal and plant cells and organs, and neurons.
- 12. A method of fabricating a substrate construction for immobilizing a physiological material comprising:

forming an organic polymer linker material layer by coating a coating composition including organic polymer linker material on a substrate;

forming a seed colloid catalytic layer by coating a gold colloid dispersion on the organic polymer linker material layer;

drying or heat-treating the substrate on which the seed colloid catalytic layer is formed; and

applying a coating composition comprising a gold salt-containing aqueous solution and a reducing agent-containing solution to form a gold thin layer.

- 13. The method according to claim 12, wherein one terminal end of the organic polymer linker material has a functional group that is capable of reacting with a functional group of the substrate and another terminal end has a functional group with a positive charge that is capable of undergoing ionic interaction with a negative charge of a gold colloid surface.
- 14. The method according to claim 12, wherein the organic polymer linker material is represented by the formula:

 $X-R_1-Si(R_2)_3$

where X is a functional group having a positive charge that is capable of undergoing ionic interaction with a negative charge of a gold colloid surface, R_1 is a spacer of $(CH_2)_n$ or $(CH_2)_n$ having one or more carboxyl or imino groups replacing one

or more of the ethylene monomers, where n is an integer from 1 to 8, and SiR₂is a functional group that is capable of reacting with functional groups on the substrate surface where each R₂ is independently selected from the group consisting of alkoxy groups, halides, and aldehyde groups.

- 15. The method according to claim 13, wherein the functional group with a positive charge is an imine group.
- 16. The method according to claim 13, wherein the organic polymer linker material is selected from the group consisting of a viologen-based compound having a formula selected from (2a), (2b) and (2c), a polymer having an imine group-containing polyethylene backbone having formula (3), a compound having formula (4) and a compound having formula (5):

O (CH2)h Si(R2)3
+N Si(R2)3

$$(CH2)h'$$
 Si(R2)3
 $(CH2)h'$ (2a)

$$+N$$
 $+N$
 HN
 $(CH_2)_i$
 $(2b)$

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$$+N$$
 $+N$
 $(CH_2)_j$
 $Si(R_2)_3$
(2c)

$$\begin{bmatrix}
H & H & H \\
N & N^{\dagger} & H \\
(CH2)k & N
\end{bmatrix}$$

$$Si(R2)3$$
(3)

$$R_{3}N$$

$$(CH_{2})_{t}$$

$$Si(R_{2})_{3}$$

$$NR_{4}$$

$$(4)$$

$$\begin{array}{c}
R_5 \\
N^{\dagger} \\
(CH_2)_{m} - Si(R_2)_3
\end{array}$$
(5)

where each R_2 is independently selected from the group consisting of alkoxy groups, halides, and aldehyde groups; h, h', I and m are integers from 1 to 8; R_3 and R_4 are independently (R_6)₂ where R_6 is a halogen or a C_1 to C_6 alkyl; and R_5 is a halogen or a C_4 to C_6 alkyl.

17. The method according to claim 16, wherein the organic polymer linker material is selected from the group consisting of a compound having a formula selected from (2a'), (2b') and (2c'), a polymer having formula (3'), a methylene bule compound having formula (4') and a phenazine methosulphate compound having formula (5'):

$$+N \longrightarrow 0 \longrightarrow Si(R_2)_3$$

$$+N \longrightarrow 0 \longrightarrow Si(R_2)_3$$

$$0 \longrightarrow Si(R_2)_3$$

$$(2a')$$

$$\begin{bmatrix}
H & CI^{-} & H \\
N^{\dagger} & N^{\dagger} & N^{\dagger}
\end{bmatrix}$$
Si(R₂)₃
(3')

$$(CH_3)_2N$$
 $Si(R_2)_3$
 $N(CH_3)_2$
 $(4')$

where each R_2 is independently selected from the group consisting of alkoxy groups, halides and aldehyde groups.

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- 18. The method according to claim 13, wherein the organic polymer linker material comprises trimethoxysilylpropyl polyethyleneimine.
- 19. The method according to claim 12, wherein the organic polymer linker material is used in an amount of 0.01 weight % to 50 weight % based on the coating composition.

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20. The method according to claim 12, wherein the organic polymer linker material is coated using a coating method selected from the group consisting of self-assembly thin layer coating, spin-coating, dipping, spraying, printing, and a Langmuir Blodgett Technique.

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21. The method according to claim 12, wherein the seed colloid catalytic layer comprises gold colloid having a particle size ranging 5nm to 500nm.

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22. The method according to claim 12, wherein the gold colloid dispersion comprises gold salt, a reducing agent, a stabilizer and a solvent.

23. The method according to claim 22, wherein the gold salt is selected from the group consisting of HAuCl₄, NaAuCl₄, and mixtures thereof.

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24. The method according to claim 22, wherein the reducing agent is selected from the group consisting of NaBH₄, thiocyanate, potassium carbonate, trisodium citrate or hydrate thereof, tannic acid, hydroxyamine or a salt thereof, and

mixtures thereof.

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- 25. The method according to claim 22, wherein the stabilizer comprises sodium citrate.
- 26. The method according to claim 12, wherein the coating method of the seed catalytic layer is selected from the group consisting of dipping, spraying, spin-coating, and printing.
- 27. The method according to claim 12, wherein the gold salt-containing aqueous solution comprises a gold salt selected from the group consisting of HAuCl₄, NaAuCl₄, and mixtures thereof.
- 28. The method according to claim 12, wherein the gold salt-containing aqueous solution comprises 0.01 weight % to 20 weight % of a gold salt.
- 29. The method according to claim 12, wherein the reducing agent of the reducing agent-containing solution is selected from the group consisting of NaBH₄, thiocyanate, potassium carbonate, trisodium citrate or hydrate thereof, tannic acid, hydroxyamine or a salt thereof, and mixtures thereof.
- 30. The method according to claim 12, wherein the reducing agent-containing solution comprises 0.01mM to 1M of a reducing agent.
- 31. The method according to claim 30, wherein the reducing agentcontaining solution comprises 0.01mM to 100mM of a reducing agent.
- 32. The method according to claim 12, wherein the coating of the gold thin layer is performed using a plating method.